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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Discontinued at Digi-Key
Core Processor	ARM7®
Core Size	16/32-Bit
Speed	60MHz
Connectivity	I ² C, Microwire, SPI, SSI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	47
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 16x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc2138fbd64-01-15

- One (LPC2131/32) or two (LPC2134/36/38) 8-channel 10-bit ADCs provide a total of up to 16 analog inputs, with conversion times as low as 2.44 μ s per channel.
- Single 10-bit DAC provides variable analog output (LPC2132/34/36/38).
- Two 32-bit timers/external event counters (with four capture and four compare channels each), PWM unit (six outputs) and watchdog.
- Low power Real-time clock with independent power and dedicated 32 kHz clock input.
- Multiple serial interfaces including two UARTs (16C550), two Fast I²C-bus (400 kbit/s), SPI and SSP with buffering and variable data length capabilities.
- Vectored interrupt controller with configurable priorities and vector addresses.
- Up to forty-seven 5 V tolerant general purpose I/O pins in tiny LQFP64 or HVQFN package.
- Up to nine edge or level sensitive external interrupt pins available.
- 60 MHz maximum CPU clock available from programmable on-chip PLL with settling time of 100 μ s.
- On-chip integrated oscillator operates with external crystal in range of 1 MHz to 30 MHz and with external oscillator up to 50 MHz.
- Power saving modes include Idle and Power-down.
- Individual enable/disable of peripheral functions as well as peripheral clock scaling down for additional power optimization.
- Processor wake-up from Power-down mode via external interrupt or BOD.
- Single power supply chip with POR and BOD circuits:
 - ◆ CPU operating voltage range of 3.0 V to 3.6 V (3.3 V \pm 10 %) with 5 V tolerant I/O pads.

3. Ordering information

Table 1. Ordering information

Type number	Package		
	Name	Description	Version
LPC2131FBD64/01	LQFP64	plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC2132FBD64/01	LQFP64	plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC2132FHN64/01	HVQFN64	plastic thermal enhanced very thin quad flat package; no leads; 64 terminals; body 9 × 9 × 0.85 mm	SOT804-2
LPC2134FBD64/01	LQFP64	plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC2136FBD64/01	LQFP64	plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC2138FBD64/01	LQFP64	plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC2138FHN64/01	HVQFN64	plastic thermal enhanced very thin quad flat package; no leads; 64 terminals; body 9 × 9 × 0.85 mm	SOT804-2

3.1 Ordering options

Table 2. Ordering options

Type number	Flash memory	RAM	ADC	DAC	Enhanced UARTs, ADC, Fast I/Os, and BOD	Temperature range
LPC2131FBD64/01	32 kB	8 kB	1	-	yes	–40 °C to +85 °C
LPC2132FBD64/01	64 kB	16 kB	1	1	yes	–40 °C to +85 °C
LPC2132FHN64/01	64 kB	16 kB	1	1	yes	–40 °C to +85 °C
LPC2134FBD64/01	128 kB	16 kB	2	1	yes	–40 °C to +85 °C
LPC2136FBD64/01	256 kB	32 kB	2	1	yes	–40 °C to +85 °C
LPC2138FBD64/01	512 kB	32 kB	2	1	yes	–40 °C to +85 °C
LPC2138FHN64/01	512 kB	32 kB	2	1	yes	–40 °C to +85 °C

5. Pinning information

5.1 Pinning

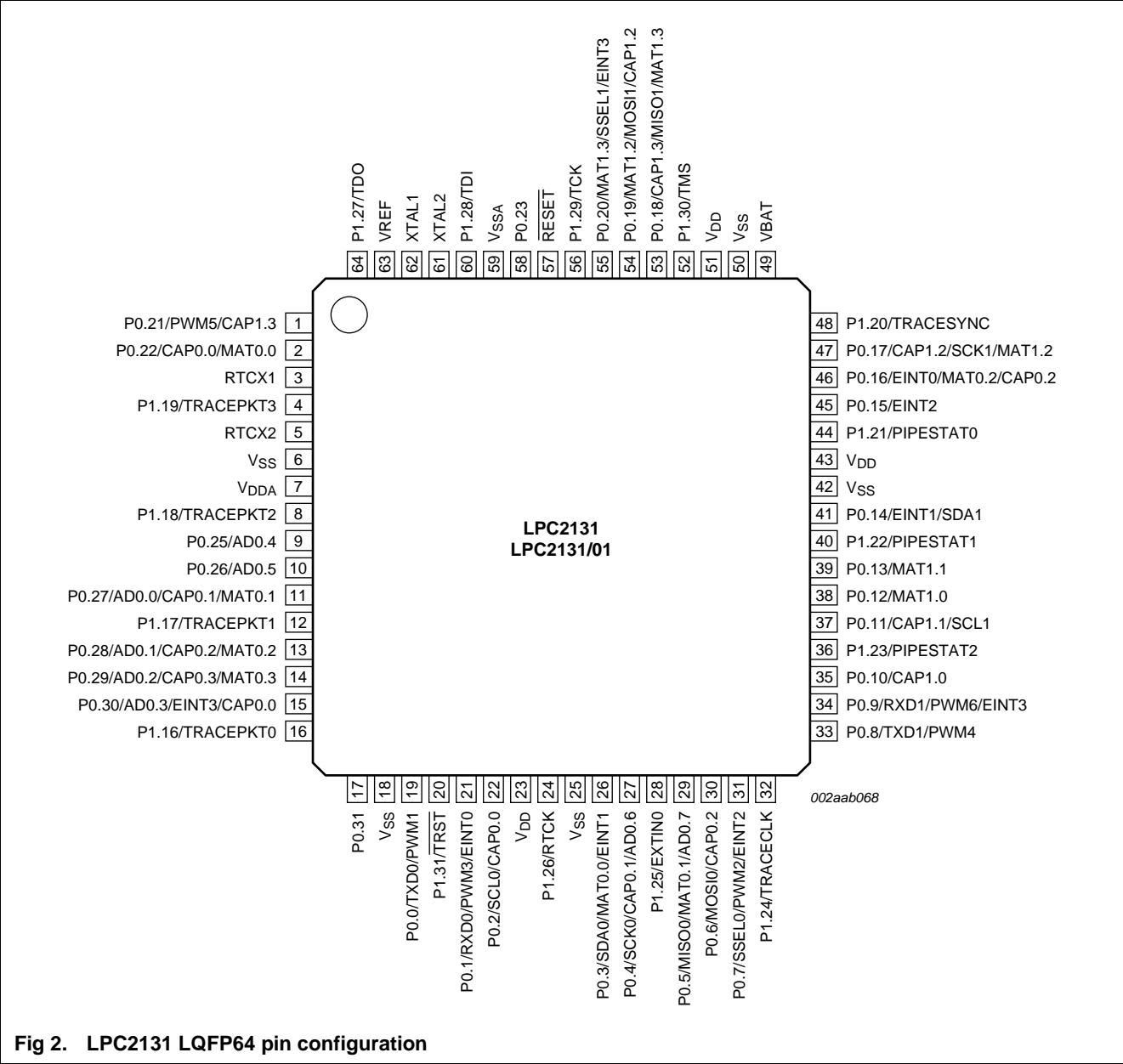


Fig 2. LPC2131 LQFP64 pin configuration

5.2 Pin description

Table 3. Pin description

Symbol	Pin	Type	Description
P0.0 to P0.31		I/O	Port 0: Port 0 is a 32-bit I/O port with individual direction controls for each bit. Total of 31 pins of the Port 0 can be used as a general purpose bidirectional digital I/Os while P0.31 is output only pin. The operation of port 0 pins depends upon the pin function selected via the pin connect block. Pin P0.24 is not available.
P0.0/TXD0/ PWM1	19 ^[1]	O	TXD0 — Transmitter output for UART0.
		O	PWM1 — Pulse Width Modulator output 1.
P0.1/RXD0/ PWM3/EINT0	21 ^[2]	I	RXD0 — Receiver input for UART0.
		O	PWM3 — Pulse Width Modulator output 3.
		I	EINT0 — External interrupt 0 input.
P0.2/SCL0/ CAP0.0	22 ^[3]	I/O	SCL0 — I ² C0 clock input/output. Open drain output (for I ² C-bus compliance).
		I	CAP0.0 — Capture input for Timer 0, channel 0.
P0.3/SDA0/ MAT0.0/EINT1	26 ^[3]	I/O	SDA0 — I ² C0 data input/output. Open drain output (for I ² C-bus compliance).
		O	MAT0.0 — Match output for Timer 0, channel 0.
		I	EINT1 — External interrupt 1 input.
P0.4/SCK0/ CAP0.1/AD0.6	27 ^[4]	I/O	SCK0 — Serial clock for SPI0. SPI clock output from master or input to slave.
		I	CAP0.1 — Capture input for Timer 0, channel 1.
		I	AD0.6 — ADC 0, input 6. This analog input is always connected to its pin.
P0.5/MISO0/ MAT0.1/AD0.7	29 ^[4]	I/O	MISO0 — Master In Slave V _{DD} = 3.6 V for SPI0. Data input to SPI master or data output from SPI slave.
		O	MAT0.1 — Match output for Timer 0, channel 1.
		I	AD0.7 — ADC 0, input 7. This analog input is always connected to its pin.
P0.6/MOSI0/ CAP0.2/AD1.0	30 ^[4]	I/O	MOSI0 — Master Out Slave In for SPI0. Data output from SPI master or data input to SPI slave.
		I	CAP0.2 — Capture input for Timer 0, channel 2.
		I	AD1.0 — ADC 1, input 0. This analog input is always connected to its pin. Available in LPC2134/36/38 only.
P0.7/SSEL0/ PWM2/EINT2	31 ^[2]	I	SSEL0 — Slave Select for SPI0. Selects the SPI interface as a slave.
		O	PWM2 — Pulse Width Modulator output 2.
		I	EINT2 — External interrupt 2 input.
P0.8/TXD1/ PWM4/AD1.1	33 ^[4]	O	TXD1 — Transmitter output for UART1.
		O	PWM4 — Pulse Width Modulator output 4.
		I	AD1.1 — ADC 1, input 1. This analog input is always connected to its pin. Available in LPC2134/36/38 only.
P0.9/RXD1/ PWM6/EINT3	34 ^[2]	I	RXD1 — Receiver input for UART1.
		O	PWM6 — Pulse Width Modulator output 6.
		I	EINT3 — External interrupt 3 input.
P0.10/RTS1/ CAP1.0/AD1.2	35 ^[4]	O	RTS1 — Request to Send output for UART1. Available in LPC2134/36/38.
		I	CAP1.0 — Capture input for Timer 1, channel 0.
		I	AD1.2 — ADC 1, input 2. This analog input is always connected to its pin. Available in LPC2134/36/38 only.

Table 3. Pin description ...continued

Symbol	Pin	Type	Description
P0.23	58 ^[1]	I/O	General purpose digital input/output pin.
P0.25/AD0.4/ AOUT	9 ^[5]	I	AD0.4 — ADC 0, input 4. This analog input is always connected to its pin.
		O	AOUT — DAC output. Not available in LPC2131.
P0.26/AD0.5	10 ^[4]	I	AD0.5 — ADC 0, input 5. This analog input is always connected to its pin.
P0.27/AD0.0/ CAP0.1/MAT0.1	11 ^[4]	I	AD0.0 — ADC 0, input 0. This analog input is always connected to its pin.
		I	CAP0.1 — Capture input for Timer 0, channel 1.
		O	MAT0.1 — Match output for Timer 0, channel 1.
P0.28/AD0.1/ CAP0.2/MAT0.2	13 ^[4]	I	AD0.1 — ADC 0, input 1. This analog input is always connected to its pin.
		I	CAP0.2 — Capture input for Timer 0, channel 2.
		O	MAT0.2 — Match output for Timer 0, channel 2.
P0.29/AD0.2/ CAP0.3/MAT0.3	14 ^[4]	I	AD0.2 — ADC 0, input 2. This analog input is always connected to its pin.
		I	CAP0.3 — Capture input for Timer 0, channel 3.
		O	MAT0.3 — Match output for Timer 0, channel 3.
P0.30/AD0.3/ EINT3/CAP0.0	15 ^[4]	I	AD0.3 — ADC 0, input 3. This analog input is always connected to its pin.
		I	EINT3 — External interrupt 3 input.
		I	CAP0.0 — Capture input for Timer 0, channel 0.
P0.31	17 ^[6]	O	General purpose digital output only pin. Important: This pin MUST NOT be externally pulled LOW when $\overline{\text{RESET}}$ pin is LOW or the JTAG port will be disabled.
P1.0 to P1.31		I/O	Port 1: Port 1 is a 32-bit bidirectional I/O port with individual direction controls for each bit. The operation of port 1 pins depends upon the pin function selected via the pin connect block. Pins 0 through 15 of port 1 are not available.
P1.16/ TRACEPKT0	16 ^[6]	O	TRACEPKT0 — Trace Packet, bit 0. Standard I/O port with internal pull-up.
P1.17/ TRACEPKT1	12 ^[6]	O	TRACEPKT1 — Trace Packet, bit 1. Standard I/O port with internal pull-up.
P1.18/ TRACEPKT2	8 ^[6]	O	TRACEPKT2 — Trace Packet, bit 2. Standard I/O port with internal pull-up.
P1.19/ TRACEPKT3	4 ^[6]	O	TRACEPKT3 — Trace Packet, bit 3. Standard I/O port with internal pull-up.
P1.20/ TRACESYNC	48 ^[6]	O	TRACESYNC — Trace Synchronization. Standard I/O port with internal pull-up. LOW on TRACESYNC while $\overline{\text{RESET}}$ is LOW enables pins P1.25:16 to operate as Trace port after reset.
P1.21/ PIPESTAT0	44 ^[6]	O	PIPESTAT0 — Pipeline Status, bit 0. Standard I/O port with internal pull-up.
P1.22/ PIPESTAT1	40 ^[6]	O	PIPESTAT1 — Pipeline Status, bit 1. Standard I/O port with internal pull-up.
P1.23/ PIPESTAT2	36 ^[6]	O	PIPESTAT2 — Pipeline Status, bit 2. Standard I/O port with internal pull-up.
P1.24/ TRACECLK	32 ^[6]	O	TRACECLK — Trace Clock. Standard I/O port with internal pull-up.
P1.25/EXTIN0	28 ^[6]	I	EXTIN0 — External Trigger Input. Standard I/O with internal pull-up.

6.7.2 Fast I/O features available in LPC213x/01 only

- Fast I/O registers are located on the ARM local bus for the fastest possible I/O timing.
- All GPIO registers are byte addressable.
- Entire port value can be written in one instruction.
- Mask registers allow single instruction to set or clear any number of bits in one port.

6.8 10-bit ADC

The LPC2131/32 contain one and the LPC2134/36/38 contain two ADCs. These converters are single 10-bit successive approximation ADCs with eight multiplexed channels.

6.8.1 Features

- Measurement range of 0 V to 3.3 V.
- Each converter capable of performing more than 400000 10-bit samples per second.
- Burst conversion mode for single or multiple inputs.
- Optional conversion on transition on input pin or Timer Match signal.
- Global Start command for both converters (LPC2134/36/38 only).

6.8.2 ADC features available in LPC213x/01 only

- Every analog input has a dedicated result register to reduce interrupt overhead.
- Every analog input can generate an interrupt once the conversion is completed.

6.9 10-bit DAC

This peripheral is available in the LPC2132/34/36/38 only. The DAC enables the LPC2132/34/36/38 to generate variable analog output.

6.9.1 Features

- 10-bit digital to analog converter.
- Buffered output.
- Power-down mode available.
- Selectable speed versus power.

6.10 UARTs

The LPC2131/32/34/36/38 each contain two UARTs. In addition to standard transmit and receive data lines, the LPC2134/36/38 UART1 also provides a full modem control handshake interface.

6.10.1 Features

- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B

6.12.1 Features

- Compliant with Serial Peripheral Interface (SPI) specification.
- Synchronous, Serial, Full Duplex, Communication.
- Combined SPI master and slave.
- Maximum data bit rate of one eighth of the input clock rate.

6.13 SSP serial I/O controller

The LPC2131/32/34/36/38 each contain one Serial Synchronous Port controller (SSP). The SSP controller is capable of operation on a SPI, 4-wire SSI, or Microwire bus. It can interact with multiple masters and slaves on the bus. However, only a single master and a single slave can communicate on the bus during a given data transfer. The SSP supports full duplex transfers, with frames of 4 bits to 16 bits of data flowing from the master to the slave and from the slave to the master. Often only one of these data flows carries meaningful data.

6.13.1 Features

- Compatible with Motorola SPI, 4-wire TI SSI and National Semiconductor Microwire buses.
- Synchronous Serial Communication.
- Master or slave operation.
- 8-frame FIFOs for both transmit and receive.
- Four bits to 16 bits per frame.

6.14 General purpose timers/external event counters

The Timer/Counter is designed to count cycles of the peripheral clock (PCLK) or an externally supplied clock, and optionally generate interrupts or perform other actions at specified timer values, based on four match registers. It also includes four capture inputs to trap the timer value when an input signal transitions, optionally generating an interrupt. Multiple pins can be selected to perform a single capture or match function, providing an application with 'or' and 'and', as well as 'broadcast' functions among them.

At any given time only one of peripheral's capture inputs can be selected as an external event signal source, i.e., timer's clock. The rate of external events that can be successfully counted is limited to PCLK/2. In this configuration, unused capture lines can be selected as regular timer capture inputs.

6.14.1 Features

- A 32-bit Timer/Counter with a programmable 32-bit Prescaler.
- External Event Counter or timer operation.
- Four 32-bit capture channels per timer/counter that can take a snapshot of the timer value when an input signal transitions. A capture event may also optionally generate an interrupt.
- Four 32-bit match registers that allow:
 - Continuous operation with optional interrupt generation on match.

- Stop timer on match with optional interrupt generation.
- Reset timer on match with optional interrupt generation.
- Four external outputs per timer/counter corresponding to match registers, with the following capabilities:
 - Set LOW on match.
 - Set HIGH on match.
 - Toggle on match.
 - Do nothing on match.

6.15 Watchdog timer

The purpose of the watchdog is to reset the microcontroller within a reasonable amount of time if it enters an erroneous state. When enabled, the watchdog will generate a system reset if the user program fails to 'feed' (or reload) the watchdog within a predetermined amount of time.

6.15.1 Features

- Internally resets chip if not periodically reloaded.
- Debug mode.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect/Incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 32-bit timer with internal pre-scaler.
- Selectable time period from $(T_{cy(PCLK)} \times 256 \times 4)$ to $(T_{cy(PCLK)} \times 2^{32} \times 4)$ in multiples of $T_{cy(PCLK)} \times 4$.

6.16 Real-time clock

The Real-Time Clock (RTC) is designed to provide a set of counters to measure time when normal or idle operating mode is selected. The RTC has been designed to use little power, making it suitable for battery powered systems where the CPU is not running continuously (Idle mode).

6.16.1 Features

- Measures the passage of time to maintain a calendar and clock.
- Ultra-low power design to support battery powered systems.
- Provides Seconds, Minutes, Hours, Day of Month, Month, Year, Day of Week, and Day of Year.
- Can use either the RTC dedicated 32 kHz oscillator input or clock derived from the external crystal/oscillator input at XTAL1. Programmable Reference Clock Divider allows fine adjustment of the RTC.
- Dedicated power supply pin can be connected to a battery or the main 3.3 V.

- Match register updates are synchronized with pulse outputs to prevent generation of erroneous pulses. Software must 'release' new match values before they can become effective.
- May be used as a standard timer if the PWM mode is not enabled.
- A 32-bit Timer/Counter with a programmable 32-bit Prescaler.

6.18 System control

6.18.1 Crystal oscillator

On-chip integrated oscillator operates with external crystal in range of 1 MHz to 30 MHz and with external oscillator up to 50 MHz. The oscillator output frequency is called f_{osc} and the ARM processor clock frequency is referred to as CCLK for purposes of rate equations, etc. f_{osc} and CCLK are the same value unless the PLL is running and connected. Refer to [Section 6.18.2 "PLL"](#) for additional information.

6.18.2 PLL

The PLL accepts an input clock frequency in the range of 10 MHz to 25 MHz. The input frequency is multiplied up into the range of 10 MHz to 60 MHz with a Current Controlled Oscillator (CCO). The multiplier can be an integer value from 1 to 32 (in practice, the multiplier value cannot be higher than 6 on this family of microcontrollers due to the upper frequency limit of the CPU). The CCO operates in the range of 156 MHz to 320 MHz, so there is an additional divider in the loop to keep the CCO within its frequency range while the PLL is providing the desired output frequency. The output divider may be set to divide by 2, 4, 8, or 16 to produce the output clock. Since the minimum output divider value is 2, it is insured that the PLL output has a 50 % duty cycle. The PLL is turned off and bypassed following a chip reset and may be enabled by software. The program must configure and activate the PLL, wait for the PLL to Lock, then connect to the PLL as a clock source. The PLL settling time is 100 μ s.

6.18.3 Reset and wake-up timer

Reset has two sources on the LPC2131/32/34/36/38: the $\overline{\text{RESET}}$ pin and watchdog reset. The $\overline{\text{RESET}}$ pin is a Schmitt trigger input pin with an additional glitch filter. Assertion of chip reset by any source starts the wake-up timer (see wake-up timer description below), causing the internal chip reset to remain asserted until the external reset is de-asserted, the oscillator is running, a fixed number of clocks have passed, and the on-chip flash controller has completed its initialization.

When the internal reset is removed, the processor begins executing at address 0, which is the reset vector. At that point, all of the processor and peripheral registers have been initialized to predetermined values.

The wake-up timer ensures that the oscillator and other analog functions required for chip operation are fully functional before the processor is allowed to execute instructions. This is important at power on, all types of reset, and whenever any of the aforementioned functions are turned off for any reason. Since the oscillator and other functions are turned off during Power-down mode, any wake-up of the processor from Power-down mode makes use of the wake-up timer.

6.18.8 Power Control

The LPC2131/32/34/36/38 support two reduced power modes: Idle mode and Power-down mode.

In Idle mode, execution of instructions is suspended until either a reset or interrupt occurs. Peripheral functions continue operation during Idle mode and may generate interrupts to cause the processor to resume execution. Idle mode eliminates power used by the processor itself, memory systems and related controllers, and internal buses.

In Power-down mode, the oscillator is shut down and the chip receives no internal clocks. The processor state and registers, peripheral registers, and internal SRAM values are preserved throughout Power-down mode and the logic levels of chip output pins remain static. The Power-down mode can be terminated and normal operation resumed by either a reset or certain specific interrupts that are able to function without clocks. Since all dynamic operation of the chip is suspended, Power-down mode reduces chip power consumption to nearly zero.

Selecting an external 32 kHz clock instead of the PCLK as a clock-source for the on-chip RTC will enable the microcontroller to have the RTC active during Power-down mode. Power-down current is increased with RTC active. However, it is significantly lower than in Idle mode.

A Power Control for Peripherals feature allows individual peripherals to be turned off if they are not needed in the application, resulting in additional power savings.

6.18.9 APB bus

The APB divider determines the relationship between the processor clock (CCLK) and the clock used by peripheral devices (PCLK). The APB divider serves two purposes. The first is to provide peripherals with the desired PCLK via APB bus so that they can operate at the speed chosen for the ARM processor. In order to achieve this, the APB bus may be slowed down to $\frac{1}{2}$ to $\frac{1}{4}$ of the processor clock rate. Because the APB bus must work properly at power-up (and its timing cannot be altered if it does not work since the APB divider control registers reside on the APB bus), the default condition at reset is for the APB bus to run at $\frac{1}{4}$ of the processor clock rate. The second purpose of the APB divider is to allow power savings when an application does not require any peripherals to run at the full processor rate. Because the APB divider is connected to the PLL output, the PLL remains active (if it was running) during Idle mode.

6.19 Emulation and debugging

The LPC2131/32/34/36/38 support emulation and debugging via a JTAG serial port. A trace port allows tracing program execution. Debugging and trace functions are multiplexed only with GPIOs on Port 1. This means that all communication, timer and interface peripherals residing on Port 0 are available during the development and debugging phase as they are when the application is run in the embedded system itself.

6.19.1 EmbeddedICE

Standard ARM EmbeddedICE logic provides on-chip debug support. The debugging of the target system requires a host computer running the debugger software and an EmbeddedICE protocol convertor. EmbeddedICE protocol convertor converts the Remote Debug Protocol commands to the JTAG data needed to access the ARM core.

The ARM core has a Debug Communication Channel function built-in. The debug communication channel allows a program running on the target to communicate with the host debugger or another separate host without stopping the program flow or even entering the debug state. The debug communication channel is accessed as a co-processor 14 by the program running on the ARM7TDMI-S core. The debug communication channel allows the JTAG port to be used for sending and receiving data without affecting the normal program flow. The debug communication channel data and control registers are mapped in to addresses in the EmbeddedICE logic.

6.19.2 Embedded trace

Since the LPC2131/32/34/36/38 have significant amounts of on-chip memory, it is not possible to determine how the processor core is operating simply by observing the external pins. The Embedded Trace Macrocell provides real-time trace capability for deeply embedded processor cores. It outputs information about processor execution to the trace port.

The ETM is connected directly to the ARM core and not to the main AMBA system bus. It compresses the trace information and exports it through a narrow trace port. An external trace port analyzer must capture the trace information under software debugger control. Instruction trace (or PC trace) shows the flow of execution of the processor and provides a list of all the instructions that were executed. Instruction trace is significantly compressed by only broadcasting branch addresses as well as a set of status signals that indicate the pipeline status on a cycle by cycle basis. Trace information generation can be controlled by selecting the trigger resource. Trigger resources include address comparators, counters and sequencers. Since trace information is compressed the software debugger requires a static image of the code being executed. Self-modifying code can not be traced because of this restriction.

6.19.3 RealMonitor

RealMonitor is a configurable software module, developed by ARM Inc., which enables real time debug. It is a lightweight debug monitor that runs in the background while users debug their foreground application. It communicates with the host using the DCC, which is present in the EmbeddedICE logic. The LPC2131/32/34/36/38 contain a specific configuration of RealMonitor software programmed into the on-chip flash memory.

Table 6. Static characteristics ...continued $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ for commercial applications, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit	
I _{BATpd}	Power-down mode battery supply current	RTC clock = 32 kHz (from RTCXn pins); T _{amb} = 25 °C					
		V _{DD} = 3.0 V; V _{i(VBAT)} = 2.5 V	[11]	-	14	-	μA
		V _{DD} = 3.0 V; V _{i(VBAT)} = 3.0 V		-	16	-	μA
		V _{DD} = 3.3 V; V _{i(VBAT)} = 3.3 V		-	18	-	μA
		V _{DD} = 3.6 V; V _{i(VBAT)} = 3.6 V		-	20	-	μA
I _{BATact}	active mode battery supply current	CCLK = 60 MHz; PCLK = 15 MHz; PCLK enabled to RTCK; RTC clock = 32 kHz (from RTCXn pins); T _{amb} = 25 °C	[11]				
		V _{DD} = 3.0 V; V _{i(VBAT)} = 3.0 V		-	78	-	μA
		V _{DD} = 3.3 V; V _{i(VBAT)} = 3.3 V		-	80	-	μA
		V _{DD} = 3.6 V; V _{i(VBAT)} = 3.6 V		-	82	-	μA
I _{BATact(opt)}	optimized active mode battery supply current	PCLK disabled to RTCK in the PCONP register; RTC clock = 32 kHz (from RTCXn pins); T _{amb} = 25 °C; V _{i(VBAT)} = 3.3 V	[11][12]				
		CCLK = 6 MHz		-	21	-	μA
		CCLK = 25 MHz		-	23	-	μA
		CCLK = 50 MHz		-	27	-	μA
		CCLK = 60 MHz		-	30	-	μA
I²C-bus pins							
V _{IH}	HIGH-level input voltage		0.7V _{DD}	-	-	V	
V _{IL}	LOW-level input voltage		-	-	0.3V _{DD}	V	
V _{hys}	hysteresis voltage		-	0.05V _{DD}	-	V	
V _{OL}	LOW-level output voltage	I _{OLS} = 3 mA	[7]	-	0.4	V	
I _{LI}	input leakage current	V _I = V _{DD}	[13]	-	2	4	μA
		V _I = 5 V	[13]	-	10	22	μA
Oscillator pins							
V _{i(XTAL1)}	input voltage on pin XTAL1		-0.5	1.8	1.95	V	
V _{o(XTAL2)}	output voltage on pin XTAL2		-0.5	1.8	1.95	V	
V _{i(RTCX1)}	input voltage on pin RTCX1		-0.5	1.8	1.95	V	
V _{o(RTCX2)}	output voltage on pin RTCX2		-0.5	1.8	1.95	V	

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The RTC typically fails when $V_{i(VBAT)}$ drops below 1.6 V.

[3] Including voltage on outputs in 3-state mode.

- [4] V_{DD} supply voltages must be present.
- [5] 3-state outputs go into 3-state mode when V_{DD} is grounded.
- [6] Please also see the errata note mentioned in the errata sheet.
- [7] Accounts for 100 mV voltage drop in all supply lines.
- [8] Only allowed for a short time period.
- [9] Minimum condition for $V_I = 4.5$ V, maximum condition for $V_I = 5.5$ V.
- [10] Applies to P1.16 to P1.25.
- [11] On pin VBAT.
- [12] Optimized for low battery consumption.
- [13] To V_{SS} .

9. Dynamic characteristics

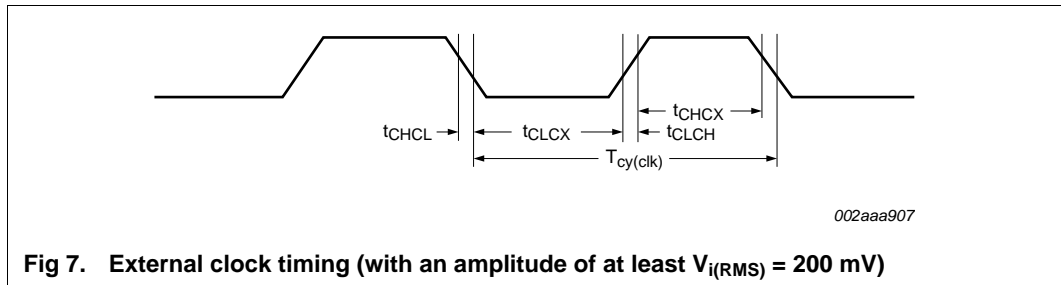
Table 7. Dynamic characteristics

$T_{amb} = -40$ °C to $+85$ °C for commercial applications, V_{DD} over specified ranges.^[1]

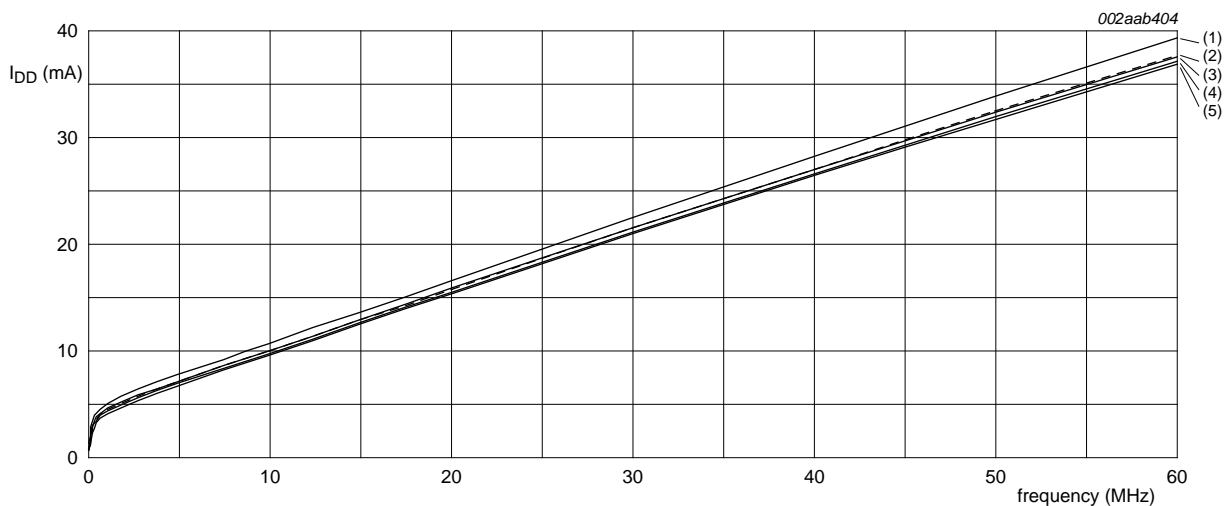
Symbol	Parameter	Conditions	Min	Typ ^[2]	Max	Unit
External clock						
f_{osc}	oscillator frequency		10	-	25	MHz
$T_{cy(clk)}$	clock cycle time		40	-	100	ns
t_{CHCX}	clock HIGH time		$T_{cy(clk)} \times 0.4$	-	-	ns
t_{CLCX}	clock LOW time		$T_{cy(clk)} \times 0.4$	-	-	ns
t_{CLCH}	clock rise time		-	-	5	ns
t_{CHCL}	clock fall time		-	-	5	ns
Port pins (except P0.2 and P0.3)						
$t_{r(o)}$	output rise time		-	10	-	ns
$t_{f(o)}$	output fall time		-	10	-	ns
I²C-bus pins (P0.2 and P0.3)						
$t_{f(o)}$	output fall time	V_{IH} to V_{IL}	$20 + 0.1 \times C_b$ ^[3]	-	-	ns

- [1] Parameters are valid over operating temperature range unless otherwise specified.
- [2] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.
- [3] Bus capacitance C_b in pF, from 10 pF to 400 pF.

9.1 Timing



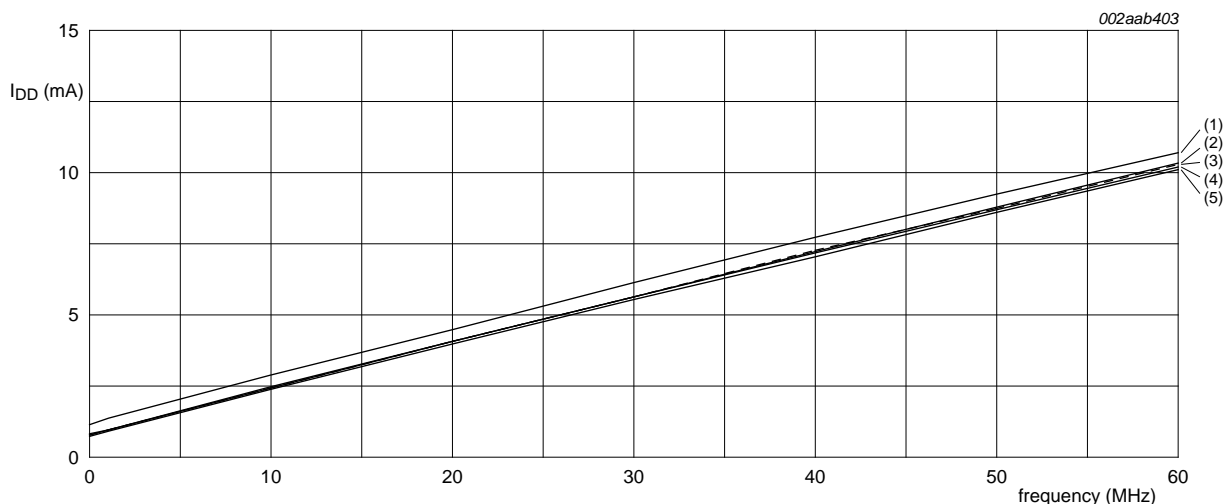
9.2 LPC2138 power consumption measurements



Test conditions: code executed from flash; all peripherals are enabled in PCONP register; PCLK = CCLK/4.

- (1) $V_{DD} = 3.6$ V at -60 °C (max)
- (2) $V_{DD} = 3.6$ V at 140 °C
- (3) $V_{DD} = 3.6$ V at 25 °C
- (4) $V_{DD} = 3.3$ V at 25 °C (typical)
- (5) $V_{DD} = 3.3$ V at 95 °C (typical)

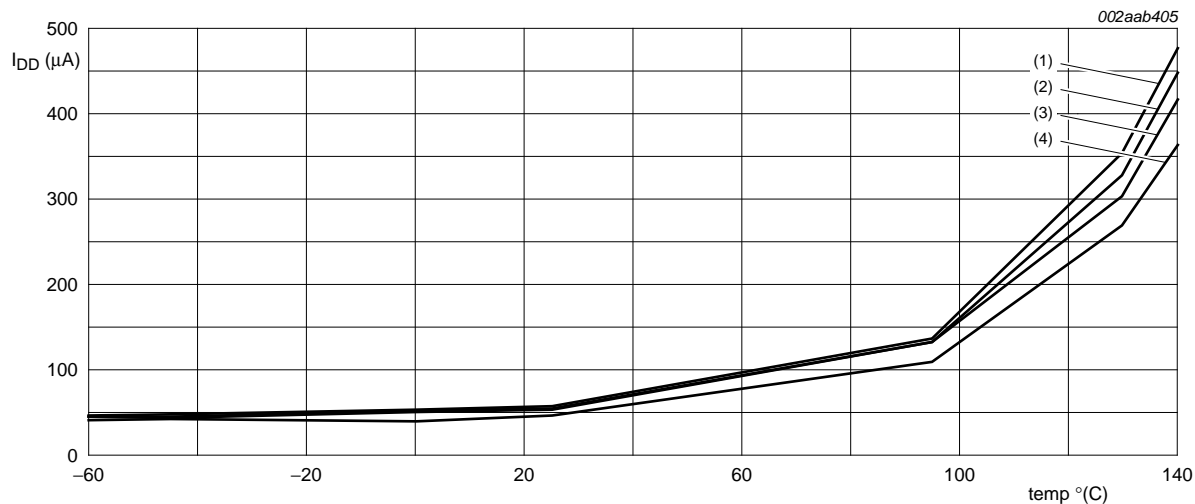
Fig 8. $I_{DD(akt)}$ measured at different frequencies (CCLK) and temperatures



Test conditions: Idle mode entered executing code from flash; all peripherals are enabled in PCONP register;
PCLK = CCLK/4.

- (1) $V_{DD} = 3.6$ V at 140 °C (max)
- (2) $V_{DD} = 3.6$ V at -60 °C
- (3) $V_{DD} = 3.6$ V at 25 °C
- (4) $V_{DD} = 3.3$ V at 25 °C (typical)
- (5) $V_{DD} = 3.3$ V at 95 °C (typical)

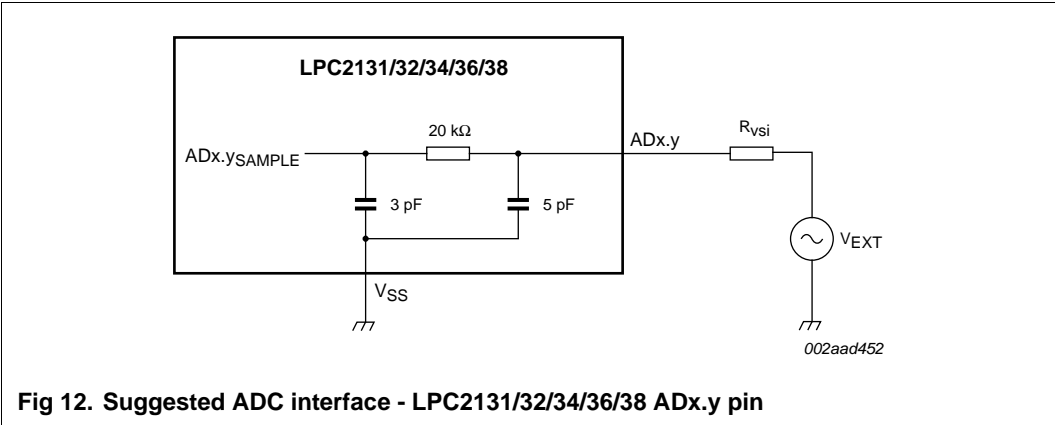
Fig 9. I_{DD} idle measured at different frequencies (CCLK) and temperatures



Test conditions: Power-down mode entered executing code from flash; all peripherals are enabled in PCONP register.

- (1) $V_{DD} = 3.6$ V
- (2) $V_{DD} = 3.3$ V (max)
- (3) $V_{DD} = 3.0$ V
- (4) $V_{DD} = 3.3$ V (typical)

Fig 10. $I_{DD(pd)}$ measured at different temperatures



14. Abbreviations

Table 13. Acronym list

Acronym	Description
A/D	Analog-to-Digital
ADC	Analog-to-Digital Converter
AHB	Advanced High-performance Bus
AMBA	Advanced Microcontroller Bus Architecture
APB	Advanced Peripheral Bus
BOD	BrownOut Detection
CPU	Central Processing Unit
DAC	Digital-to-Analog Converter
DCC	Debug Communications Channel
ETM	Embedded Trace Macrocell
FIFO	First In, First Out
GPIO	General Purpose Input/Output
JTAG	Joint Test Action Group
LSB	Least Significant Bit
PLL	Phase-Locked Loop
POR	Power-On Reset
PWM	Pulse Width Modulator
RAM	Random Access Memory
SPI	Serial Peripheral Interface
SRAM	Static Random Access Memory
SSP	Synchronous Serial Port
UART	Universal Asynchronous Receiver/Transmitter

15. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
LPC2131_32_34_36_38 v.5.1	20110729	Product data sheet	-	LPC2131_32_34_36_38 v.5
Modifications:	<ul style="list-style-type: none"> Parameter I_{sink} added in Table 5 "Limiting values". Table 6 "Static characteristics": Updated crystal oscillator specs 			
LPC2131_32_34_36_38 v.5	20110202	Product data sheet	-	LPC2131_32_34_36_38 v.4
Modifications:	<ul style="list-style-type: none"> Table 3 "Pin description": Added Table note [9] to RTCX1 and RTCX2 pins. Table 6 "Static characteristics", I²C-bus pins: Changed typical hysteresis voltage from $0.5V_{\text{DD}}$ to $0.05V_{\text{DD}}$. Table 6 "Static characteristics": Removed table note for V_{IH} and V_{IL}. Changed all occurrences of VPB to APB. Table 6 "Static characteristics": Added Table note [6] to V_{I}. Table 6 "Static characteristics", Standard port pins, RESET, RTCK: V_{hys} hysteresis voltage (0.4 V) moved from typical to minimum. Table 6 "Static characteristics": Changed $V_{\text{I(VREF)}}$ minimum voltage from 3.0 V to 2.5 V. Table 6 "Static characteristics": Updated min, typical and max values for oscillator pins $V_{\text{I(XTAL1)}}$, $V_{\text{O(XTAL2)}}$, $V_{\text{I(RTCX1)}}$, and $V_{\text{O(RTCX2)}}$. Added Section 11 "DAC electrical characteristics". Added Section 12 "Application information". 			
LPC2131_32_34_36_38 v.4	20071016	Product data sheet	-	LPC2131_32_34_36_38 v.3
LPC2131_32_34_36_38 v.3	20060921	Product data sheet	-	LPC2131_32_34_36_38 v.2
LPC2131_32_34_36_38 v.2	20050318	Preliminary data sheet	-	LPC2131_2132_2138 v.1
LPC2131_2132_2138 v.1	20041118	Preliminary data sheet	-	-

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